



DM54/74S475 (512 x 8) 4096-Bit TTL PROM

General Description

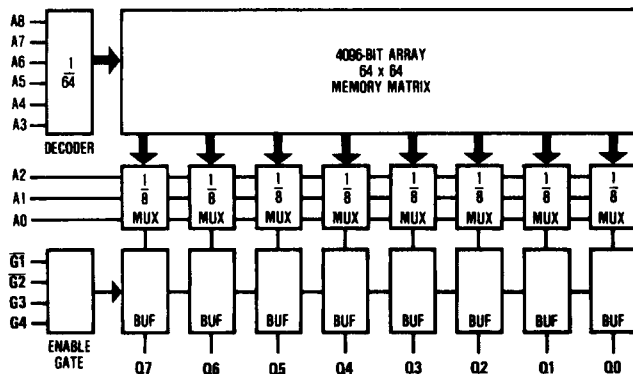
This Schottky memory is organized in the popular 512 words by 8 bits configuration. Memory enable inputs are provided to control the output states. When the device is enabled, the outputs represent the contents of the selected word. When disabled, the 8 outputs go to the "OFF" or high impedance state.

PROMs are shipped from the factory with lows in all locations. A high may be programmed into any selected location by following the programming instructions.

Features

- Advanced titanium-tungsten (Ti-W) fuses
- Schottky-clamped for high speed
 - Address access—down to 45 ns max
 - Enable access—25 ns max
 - Enable recovery—25 ns max
- PNP inputs for reduced input loading
- All DC and AC parameters guaranteed over temperature
- Low voltage TRI-SAFETM programming
- Open-collector outputs

Block Diagram

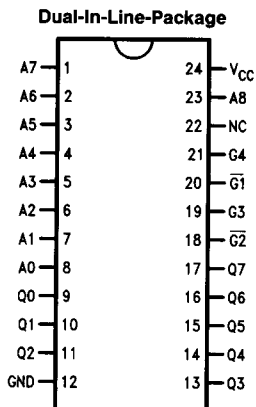


Pin Names

A0–A8	Addresses
$\overline{G1}$, $\overline{G2}$, G3, G4	Output Enables
GND	Ground
NC	No Connection
Q0–Q7	Outputs
V _{CC}	Power Supply

TL/D/9192-1

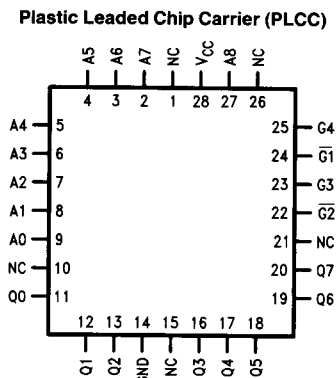
Connection Diagrams



Top View

TL/D/9192-2

Order Number DM54/74S475J, 475AJ,
DM74S475N or 475AN
See NS Package Number J24A or N24A



Top View

TL/D/9192-3

Order Number DM74S475V or 475AV
See NS Package Number V28A

Ordering Information

Commercial Temp Range (0°C to +70°C)

Parameter/Order Number	Max Access Time (ns)
DM74S475AJ	45
DM74S475J	65
DM74S475AN	45
DM74S475N	65
DM74S475AV	45
DM74S475V	65

Military Temp Range (–55°C to +125°C)

Parameter/Order Number	Max Access Time (ns)
DM54S475AJ	60
DM54S475J	75

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (Note 2)	−0.5V to +7.0V
Input Voltage (Note 2)	−1.2V to +5.5V
Output Voltage (Note 2)	−0.5V to +5.5V
Storage Temperature	−65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	300°C

ESD rating to be determined.

Note 1: Absolute maximum ratings are those values beyond which the device may be permanently damaged. They do not mean that the device may be operated at these values.

Note 2: These limits do not apply during programming. For the programming ratings, refer to the programming instructions.

Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})			
Military	4.50	5.50	V
Commercial	4.75	5.25	V
Ambient Temperature (T_A)			
Military	−55	+125	°C
Commercial	0	+70	°C
Logical "0" Input Voltage	0	0.8	V
Logic "1" Input Voltage	2.0	5.5	V

DC Electrical Characteristics (Note 1)

Symbol	Parameter	Conditions	DM54S475			DM74S475			Units
			Min	Typ	Max	Min	Typ	Max	
I_{IL}	Input Load Current	$V_{CC} = \text{Max}, V_{IN} = 0.45V$		−80	−250		−80	−250	μA
I_{IH}	Input Leakage Current	$V_{CC} = \text{Max}, V_{IN} = 2.7V$			25			25	μA
		$V_{CC} = \text{Max}, V_{IN} = 5.5V$			1.0			1.0	mA
V_{OL}	Low Level Output Voltage	$V_{CC} = \text{Min}, I_{OL} = 16 \text{ mA}$		0.35	0.50		0.35	0.45	V
V_{IL}	Low Level Input Voltage				0.80			0.80	V
V_{IH}	High Level Input Voltage		2.0			2.0			V
I_{OZ}	Output Leakage Current (Open-Collector Only)	$V_{CC} = \text{Max}, V_{CEX} = 2.4V$			50			50	μA
		$V_{CC} = \text{Max}, V_{CEX} = 5.5V$			100			100	μA
V_C	Input Clamp Voltage	$V_{CC} = \text{Min}, I_{IN} = -18 \text{ mA}$		−0.8	−1.2		−0.8	−1.2	V
C_I	Input Capacitance	$V_{CC} = 5.0V, V_{IN} = 2.0V$ $T_A = 25^\circ C, 1 \text{ MHz}$		4.0			4.0		pF
C_O	Output Capacitance	$V_{CC} = 5.0V, V_O = 2.0V$ $T_A = 25^\circ C, 1 \text{ MHz}, \text{Outputs Off}$		6.0			6.0		pF
I_{CC}	Power Supply Current	$V_{CC} = \text{Max}, \text{Inputs Grounded}$ All Outputs Open		115	170		115	170	mA

Note 1: These limits apply over the entire operating range unless stated otherwise. All typical values are for $V_{CC} = 5.0V$ and $T_A = 25^\circ C$.

AC Electrical Characteristics (With Standard Load and Operating Conditions)**COMMERCIAL TEMP RANGE (0°C to +70°C)**

Symbol	JEDEC Symbol	Parameter	DM74S475			DM74S475A			Units
			Min	Typ	Max	Min	Typ	Max	
T _{AA}	TAVQV	Address Access Time		40	65		25	45	ns
T _{EA}	TEVQV	Enable Access Time		20	35		15	25	ns
T _{ER}	TEXQX	Enable Recovery Time		20	35		15	25	ns
T _{ZX}	TEVQX	Output Enable Time		20	35		15	25	ns
T _{XZ}	TEXQZ	Output Disable Time		20	35		15	25	ns

MILITARY TEMP RANGE (-55°C to +125°C)

Symbol	JEDEC Symbol	Parameter	DM54S475			DM54S475A			Units
			Min	Typ	Max	Min	Typ	Max	
T _{AA}	TAVQV	Address Access Time		40	75		25	60	ns
T _{EA}	TEVQV	Enable Access Time		20	40		15	35	ns
T _{ER}	TEXQX	Enable Recovery Time		20	40		15	35	ns
T _{ZX}	TEVQX	Output Enable Time		20	40		15	35	ns
T _{XZ}	TEXQZ	Output Disable Time		20	40		15	35	ns

Functional Description**TESTABILITY**

The Schottky PROM die includes extra rows and columns of fusible links for testing the programmability of each chip. These test fuses are placed at the worst-case chip locations to provide the highest possible confidence in the programming tests in the final product. A ROM pattern is also permanently fixed in the additional circuitry and coded to provide a parity check of input address levels. These and other test circuits are used to test for correct operation of the row and column-select circuits and functionality of input and enable gates. All test circuits are available at both wafer and assembled device levels to allow 100% functional and parametric testing at every stage of the test flow.

RELIABILITY

As with all National products, the Ti:W PROMs are subjected to an on-going reliability evaluation by the Reliability Assurance Department. These evaluations employ accelerated life tests, including dynamic high-temperature operating life, temperature-humidity life, temperature cycling, and thermal shock. To date, nearly 7.4 million Schottky Ti:W PROM device hours have been logged, with samples in Epoxy B molded DIP (N-package), PLCC (V-package) and Cerdip (J-package). Device performance in all package configurations is excellent.

TITANIUM-TUNGSTEN FUSES

National's Programmable Read-Only Memories (PROMs) feature titanium-tungsten (Ti:W) fuse links designed to program efficiently with only 10.5V applied. The high performance and reliability of these PROMs are the result of fabrication by a Schottky bipolar process, of which the titanium-tungsten metallization is an integral part, and the use of an on-chip programming circuit.

A major advantage of the titanium-tungsten fuse technology is the low programming voltage of the fuse links. At 10.5V, this virtually eliminates the need for guard-ring devices and wide spacings required for other fuse technologies. Care is taken, however, to minimize voltage drops across the die and to reduce parasitics. The device is designed to ensure that worst-case fuse operating current is low enough for reliable long-term operation. The Darlington programming circuit is liberally designed to insure adequate power density for blowing the fuse links. The complete circuit design is optimized to provide high performance over the entire operating ranges of V_{CC} and temperature.